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REC 1302  
Chg Rec 13X1.  
SFS 030  
Heitbrink



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C.  
J.L.  
2-1694

Docket No.: 392.1290-C/JMJ

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Masao KAMIGUCHI et al.

Serial No.: 07/930,404 (parent)

08/154,126

Filed: November 18, 1993

September 14, 1992 (parent)

For: PRESSURE WAVEFORM SETTING METHOD  
FOR INJECTION PRESSURE CONTROL  
AND AN INJECTION MOLDING MACHINE

Group Art Unit: 1307

Examiner: J. Heitbrink

Honorable Commissioner of  
Patents & Trademarks  
Washington, D.C. 20231

Sir:

The following amendments and remarks are respectfully submitted.

IN THE CLAIMS:

Please AMEND the claims as follows.

1. (TWICE AMENDED) A pressure waveform setting method for injection pressure control of a resin, comprising the steps of:  
adjusting [a] at least one molding condition for injection pressure control of the resin, to generate [an] at least one adjusted molding condition;  
performing injection pressure control of the resin,  
based on the at least one adjusted molding condition;  
detecting a pressure acting on a resin during an injection/dwell stage of the injection pressure control [when a conforming molded article is obtained as] to generate an injection pressure waveform based on a function of time[, using the adjusted molding condition]; and